



# THE DATASHEET OF RS2DA



## 1.5A, 50V - 1000V Fast Recovery Surface Mount Rectifier

### FEATURES

- Glass passivated chip junction
- Ideal for automated placement
- Fast switching for high efficiency
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free

### APPLICATIONS

- DC to DC converter
- Switching mode converters and inverters
- Lighting application
- Snubber
- General purpose

### MECHANICAL DATA

- Case: DO-214AC (SMA)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.060g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
$I_F$	1.5	A
$V_{RRM}$	50 - 1000	V
$I_{FSM}$	50	A
$T_{J\ MAX}$	175	°C
Package	DO-214AC (SMA)	
Configuration	Single die	



**DO-214AC (SMA)**



ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$ unless otherwise noted)										
PARAMETER	SYMBOL	RS 2AA	RS 2BA	RS 2DA	RS 2GA	RS 2JA	RS 2KA	RS 2MA	UNIT	
Marking code on the device		RS 2AA	RS 2BA	RS 2DA	RS 2GA	RS 2JA	RS 2KA	RS 2MA		
Repetitive peak reverse voltage	$V_{RRM}$	50	100	200	400	600	800	1000	V	
Reverse voltage, total rms value	$V_{R(RMS)}$	35	70	140	280	420	560	700	V	
Forward current	$I_F$	1.5								A
Peak forward surge current, 8.3ms single half sine wave superimposed on rated load	$I_{FSM}$	50								A
Junction temperature	$T_J$	- 55 to +175								°C
Storage temperature	$T_{STG}$	- 55 to +175								°C

<b>THERMAL PERFORMANCE</b>			
<b>PARAMETER</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>UNIT</b>
Junction-to-lead thermal resistance	$R_{\theta JL}$	18	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	55	°C/W

<b>ELECTRICAL SPECIFICATIONS</b> ( $T_A = 25^\circ\text{C}$ unless otherwise noted)						
<b>PARAMETER</b>		<b>CONDITIONS</b>	<b>SYMBOL</b>	<b>TYP</b>	<b>MAX</b>	<b>UNIT</b>
Forward voltage <sup>(1)</sup>		$I_F = 1.5\text{A}, T_J = 25^\circ\text{C}$	$V_F$	-	1.3	V
Reverse current @ rated $V_R$ <sup>(2)</sup>		$T_J = 25^\circ\text{C}$	$I_R$	-	5	$\mu\text{A}$
		$T_J = 125^\circ\text{C}$		-	200	$\mu\text{A}$
Junction capacitance		1MHz, $V_R = 4.0\text{V}$	$C_J$	50	-	pF
Reverse recovery time	RS2AA RS2BA RS2DA RS2GA	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	$t_{rr}$	-	150	ns
	RS2JA			-	250	ns
	RS2KA RS2MA			-	500	ns

**Notes:**

1. Pulse test with  $PW = 0.3\text{ms}$
2. Pulse test with  $PW = 30\text{ms}$

<b>ORDERING INFORMATION</b>		
<b>ORDERING CODE<sup>(1)</sup></b>	<b>PACKAGE</b>	<b>PACKING</b>
RS2xA	DO-214AC (SMA)	7,500 / Tape & Reel

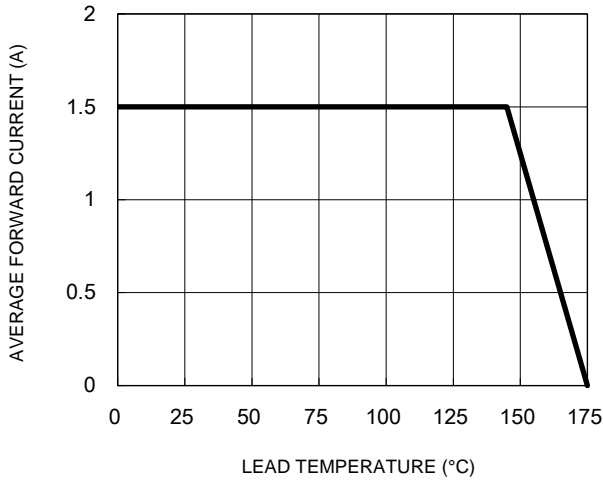
**Notes:**

1. "x" defines voltage from 50V(RS2AA) to 1000V(RS2MA)

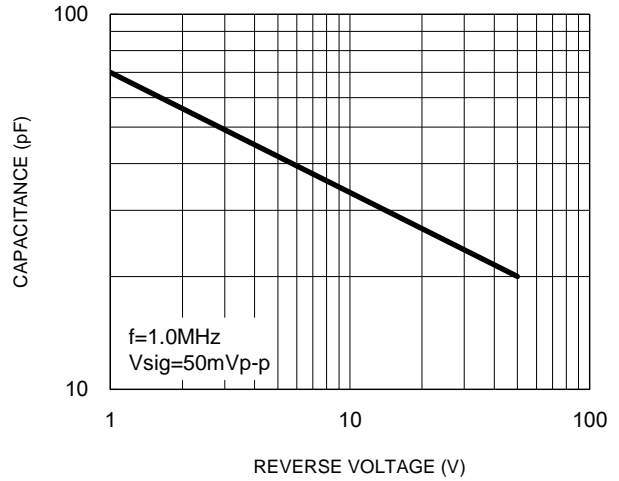
**CHARACTERISTICS CURVES**

( $T_A = 25^\circ\text{C}$  unless otherwise noted)

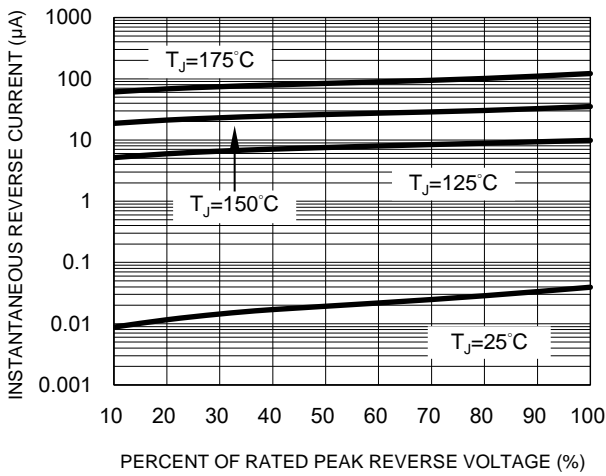
**Fig.1 Forward Current Derating Curve**



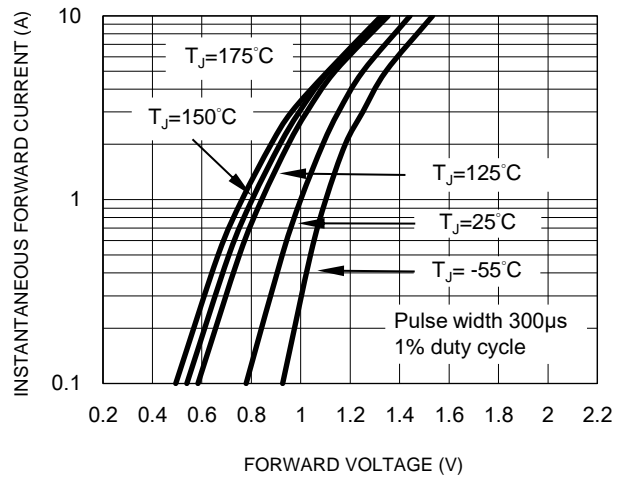
**Fig.2 Typical Junction Capacitance**



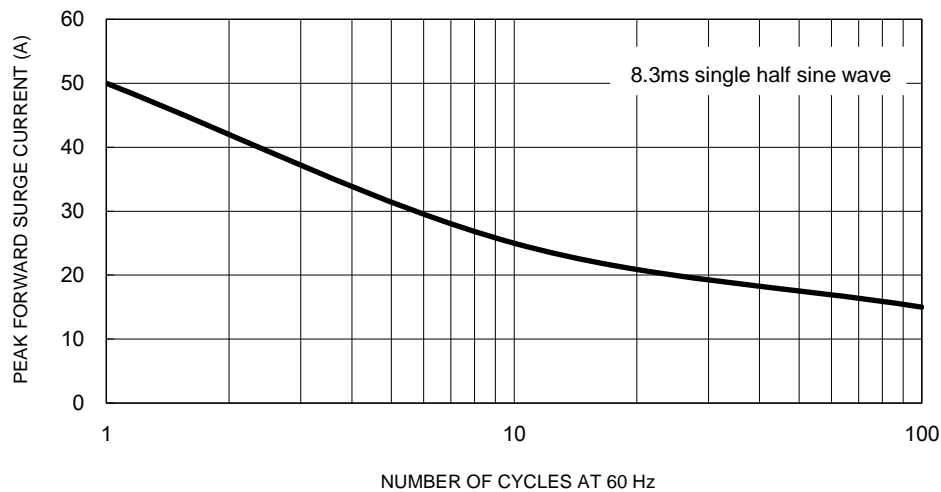
**Fig.3 Typical Reverse Characteristics**



**Fig.4 Typical Forward Characteristics**



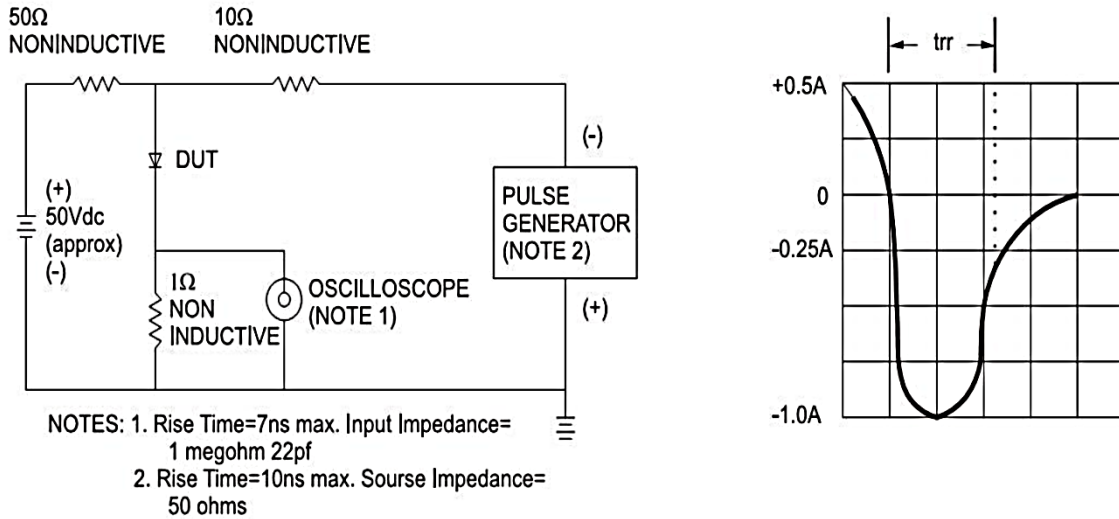
**Fig.5 Maximum Non-Repetitive Forward Surge Current**



**CHARACTERISTICS CURVES**

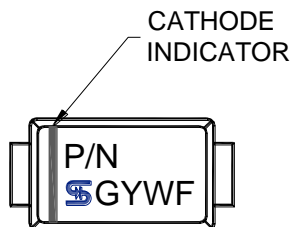
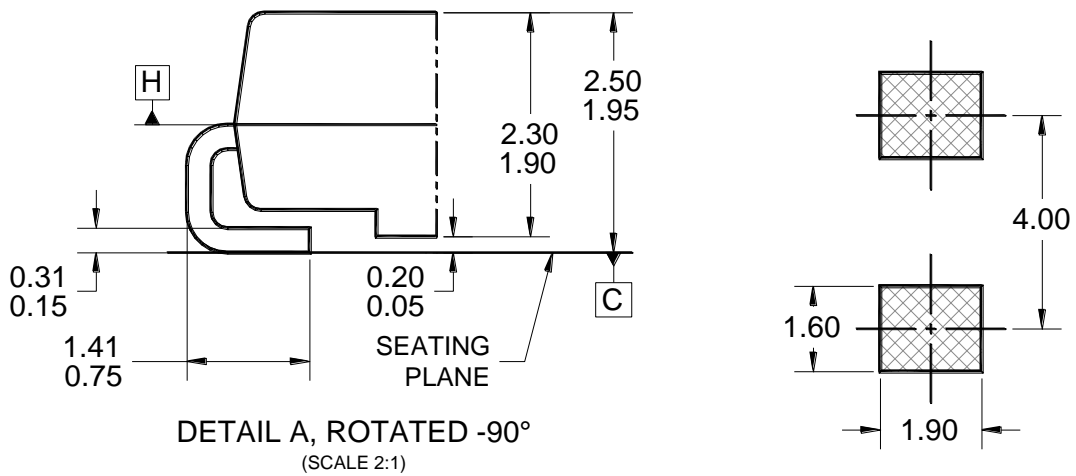
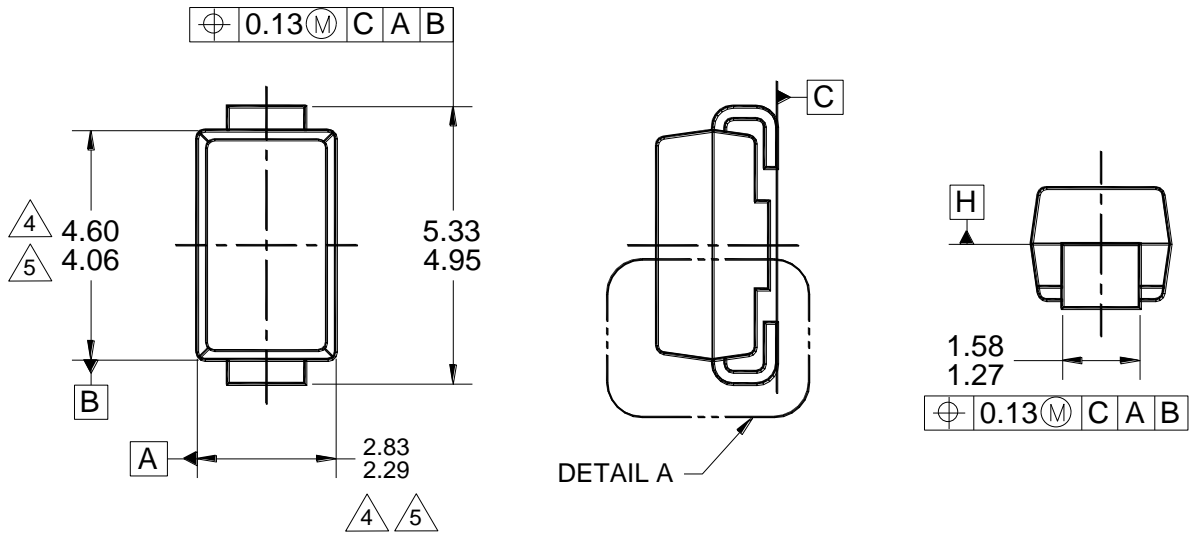
(T<sub>A</sub> = 25°C unless otherwise noted)

**Fig.6 Reverse Recovery Time Characteristic And Test Circuit Diagram**



**PACKAGE OUTLINE DIMENSIONS**

**DO-214AC (SMA)**



**MARKING DIAGRAM**

P/N = MARKING CODE  
G = GREEN COMPOUND  
YW = DATE CODE  
F = FACTORY CODE

**NOTES: UNLESS OTHERWISE SPECIFIED**

1. ALL DIMENSIONS ARE IN MILLIMETERS.
2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
3. PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AC, ISSUE D.
4. MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
5. MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
6. DWG NO. REF: HQ2SD07-DO214SMC-034 REV A.

## **Notice**

Specifications of the products displayed herein are subject to change without notice. TSC or anyone on its behalf, assumes no responsibility or liability for any errors or inaccuracies.

Purchasers are solely responsible for the choice, selection, and use of TSC products and TSC assumes no liability for application assistance or the design of Purchasers' products.

Information contained herein is intended to provide a product description only. No license, express or implied, to any intellectual property rights is granted by this document. Except as provided in TSC's terms and conditions of sale for such products, TSC assumes no liability whatsoever, and disclaims any express or implied warranty, relating to sale and/or use of TSC products including liability or warranties relating to fitness for a particular purpose, merchantability, or infringement of any patent, copyright, or other intellectual property right.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications. Customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify TSC for any damages resulting from such improper use or sale.

## Looking for pricing, stock, or lifecycle information?

Click below to explore more details on WIN SOURCE:

- ⊖ [View RS2DA on WIN SOURCE](#)
- ⊖ [Taiwan Semiconductor Information](#)

## Optimize Your Supply Chain with WIN SOURCE Solutions

- ✓ Global Sourcing Solution
- ✓ Obsolete Management
- ✓ Cost Control Management
- ✓ Shortage Management
- ✓ Alternative Solution
- ✓ Excess Inventory Management